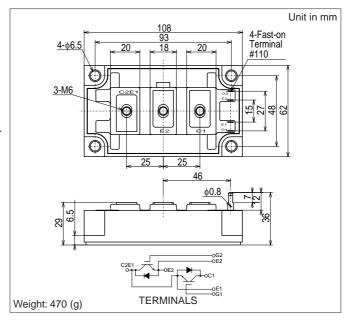
# MBM200JS12AW

Silicon N-channel IGBT

#### **OUTLINE DRAWING**

#### **FEATURES**

- \* High speed and low saturation voltage.
- \* low noise due to built-in free-wheeling diode ultra soft fast recovery diode(USFD).
- \* Isolated head sink (terminal to base).



ABSOLUTE MAXIMUM RATINGS (Tc=25°C)

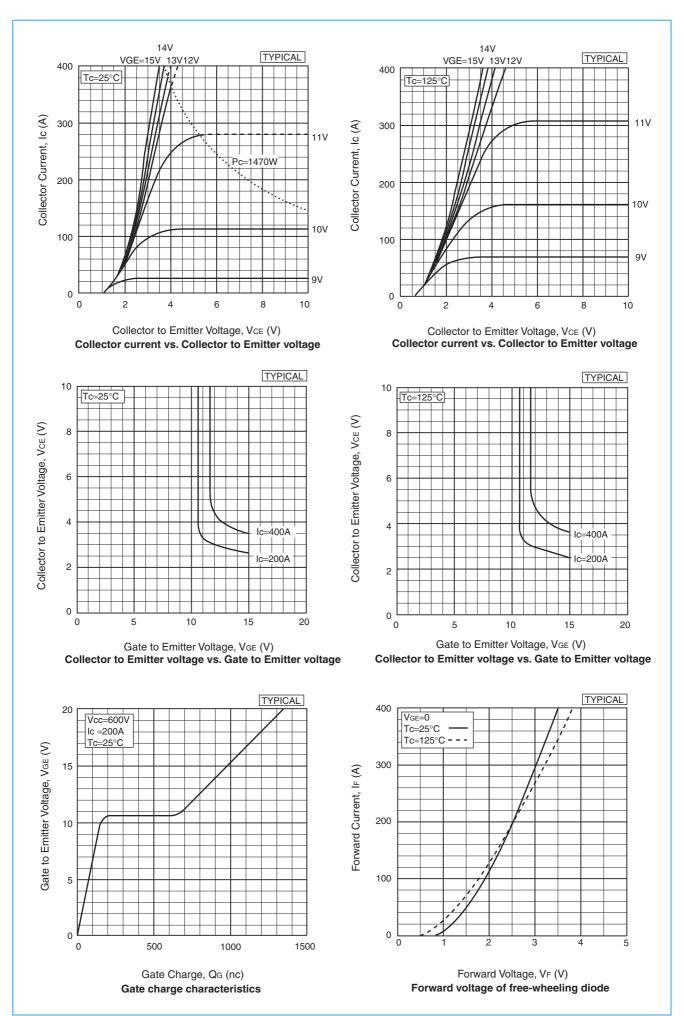
Item		Symbol	Unit	MBM200JS12AW		
Collector Emitter Voltage		Vces	V	1,200		
Gate Emitter Voltage		$V_{GES}$	V	±20		
Collector Current	DC	Ic	Α	200		
	1ms	I <sub>Cp</sub>	A	400		
Forward Current De		l <sub>F</sub>	Α	200 (1)		
	1ms	I <sub>FM</sub>	A	400		
Collector Power Dissipation		Pc	W	1,470		
Junction Temperature		Tj	°C	-40 ~ +150		
Storage Temperature		T <sub>stg</sub>	°C	-40 ~ +125		
Isolation Voltage		V <sub>ISO</sub>	$V_{RMS}$	2,500(AC 1 minute)		
Screw Torque Terminals Mounting		-	N.m	2.94(30) (2)		
		-	(kgf.cm)	2.94(30) (3)		

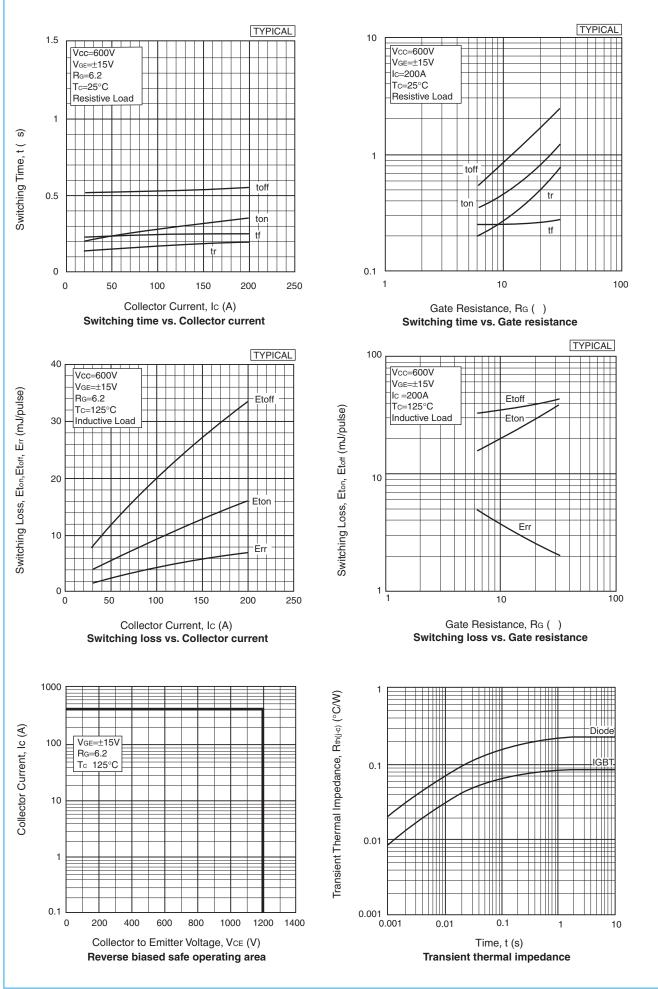
Notes:(1)RMS Current of Diode 60Arms max. (2)(3)Recommended Value 2.45N.m(25kgf.cm)

### CHARACTERISTICS (Tc=25°C)

Item		Symbol	Unit	Min.	Тур.	Max.	Test Conditions
Collector Emitter Cut-Off Current		I <sub>CES</sub>	mA	-	-	1.0	V <sub>CE</sub> =1,200V,V <sub>GE</sub> =0V
Gate Emitter Leakage Current		I <sub>GES</sub>	nA	-	-	±500	V <sub>GE</sub> =±20V,V <sub>CE</sub> =0V
Collector Emitter Saturation Voltage		V <sub>CE(sat)</sub>	V	-	2.7	3.4	Ic=200A,V <sub>GE</sub> =15V
Gate Emitter Threshold Voltage		V <sub>GE(TO)</sub>	V	-	-	10	$V_{CE}=5V$ , $I_{C}=200mA$
Input Capacitance		Cies	рF	-	21,000	-	$V_{CE}=10V, V_{GE}=0V, f=1MHz$
	Rise Time	tr		-	0.2	0.35	Vcc=600V
Switching Times	Turn On Time	ton	μS	-	0.35	0.55	R <sub>L</sub> =3.0Ω
· ·	Fall Time	t <sub>f</sub>		-	0.25	0.35	$R_G=6.2\Omega$ (4)
	Turn Off Time	t <sub>off</sub>		-	0.55	1.0	V <sub>GE</sub> =±15V
Peak Forward Voltage Drop		V <sub>FM</sub>	V	-	2.5	3.5	I <sub>F</sub> =200A,V <sub>GE</sub> =0V
Reverse Recovery Time		trr	μS	-	-	0.35	I <sub>F</sub> =200A,V <sub>GE</sub> =-10V, di/dt=300A/μs
Thermal Impedance IGBT		Rth(j-c)	°C/W	-	-	0.085	Junction to case
	FWD	Rth(j-c)		-	-	0.22	

Notes:(4)  $R_G$  value is the test condition's value for decision of the switching times, not recommended value. Determine the suitable  $R_G$  value after the measurement of switching waveforms (overshoot voltage, etc.) with appliance mounted.





## HITACHI POWER SEMICONDUCTORS

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